FOR HIGH SPEED SWITCHING APPLICATION SILICON EPITAXIAL TYPE

DESCRIPTION

MC2843 is a super mini package plastic seal type silicon epitaxial type diode,especially designed for high speed switching application.

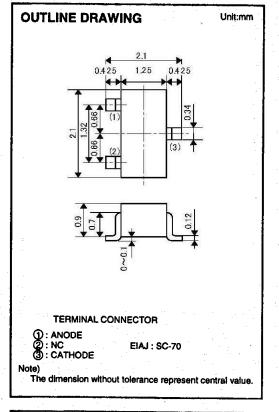
Due to the small pin capacitance, short switching time (reverse recovery time), it is most suitable for high speed switching application and limitter, clipper application.

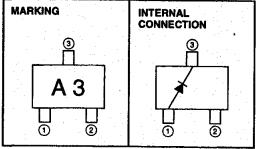
FEATURE

- Small pin capacitance
- Quick switching time
- High voltage
- Super mini package for mounting

APPLICATION

For general high speed switching of audio machine, VCR.





MAXIMUM RATINGS (Ta=25°C)

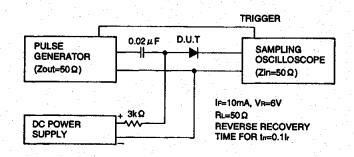
Symbol	Parameter	meter Ratings		
VRM	Peak reverse voltage	75	V	
VR	DC reverse voltage	50	V	
İFSM	Surge current(1 µs) 4		A	
İFM	Peak forward current	300	mA	
lo	Average rectification current	100	mA	
PT	Total allowable dissipation(Ta=25°C) 150		mW	
Tj	Junction temperature	+125	c	
Tstg	Storage temperature	-55 to +125	c	

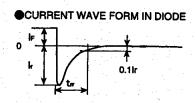
ELECTRICAL CHARACTERISTICS (Ta=25°C)

Symbol	Parameter	Tec	Test conditions		Limits		1.1-11
		163	i cordinoris	Min	Typ	Max	Unit
VF1	Forward voltage	1 F =10mA			0.72	0.9	V
VF2	Forward voltage	I F =50mA			0.85	1.0	V
VF3	Forward voltage	I F =100mA			0.90	1.2	v
la	Reverse current	VR =50V				0.1	μA
Cı	Pin capacitance	VR =0,f=1MHz			1.3	4.0	ρF
trr	Reverse recovery time	(Refer to test circuit)				3.0	ns

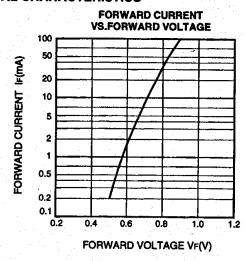
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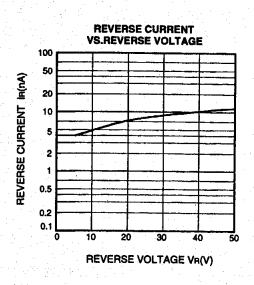
REVERSE RECOVERY TIME(trr)TEST CIRCUIT

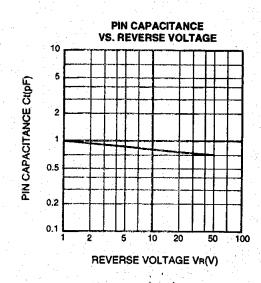


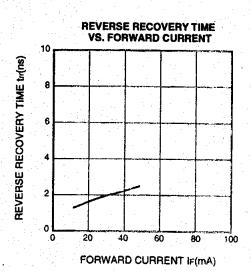


TYPICAL CHARACTERISTICS











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